

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MINCHEOL HA	12/20/2019
DONGZO KIM	12/20/2019
JI-WON KIM	12/20/2019
JAE-WAN PARK	12/20/2019
CHANG-HAK O	12/20/2019
JONGCHUL HONG	12/20/2019
YONG SANG YUN	12/20/2019
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16640017
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ATTORNEY DOCKET NUMBER:	SAMS06-18098
NAME OF SUBMITTER:	JACOB L. LACOMBE
SIGNATURE:	/Jacob L. LaCombe, Reg. No. 63,036/
DATE SIGNED:	02/18/2020

Total Attachments: 2

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ASSIGNMENT

WHEREAS, We, Mincheol HA, resident of Suwon-si, Gyeonggi-do, Republic of Korea, Dongzo KIM, resident of Yongin-si, Gyeonggi-do, Republic of Korea, Ji-Won KIM, resident of Suwon-si, Gyeonggi-do, Republic of Korea, Jae-Wan PARK, resident of Yongin-si, Gyeonggi-do, Republic of Korea, Chang-Hak O, resident of Suwon-si, Gyeonggi-do, Republic of Korea, Jongchul HONG, resident of Seongnam-si, Gyeonggi-do, Republic of Korea, and Yong Sang YUN, resident of Osan-si, Gyeonggi-do, Republic of Korea, have invented certain new and useful improvements in a "COVER COMPRISING RELAY COIL FOR WIRELESS CHARGING, OR ELECTRONIC DEVICE COMPRISING SAME" disclosed in an application for United States Letters Patent (Application Serial No. 16/640,017, filed on February 18, 2020), said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD., a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the

expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: 2019. 12. 20 Ha Mincheol
Mincheol HA

Date: 2019. 12. 20 Dongzo Kim
Dongzo KIM

Date: 2019. 12. 20 Ji-Won KIM
Ji-Won KIM

Date: 2019. 12. 20 Jae-Wan Park
Jae-Wan PARK

Date: 2019. 12. 20 Chang-Hak O
Chang-Hak O

Date: 2019. 12. 20 Jongchul Hong
Jongchul HONG

Date: 2019. 12. 20 Yong Sang Yum
Yong Sang YUN